Product Change Notification

Change Notification #: 118018 - 00
Change Title: Select Intel® Optane™ Memory M10 Series SKUs, PCN 118018-00, Product Discontinuance, Product End of Life
Date of Publication: January 13, 2021

Key Characteristics of the Change:
Product Discontinuance

Forecasted Key Milestones:

| Last Product Discontinuance Order Date: | October 2020 - January 13, 2021 |
| Last Product Discontinuance Shipment Date: | February 26, 2021 |

Description of Change to the Customer:
Intel will be discontinuing the production of the Intel® Optane™ Memory M10 Series SKUs found in the Product Affected/Intel Ordering Codes table below.

Customer Impact of Change and Recommended Action:
The Intel® Optane™ Memory H20 with Solid State Storage is the recommended transition product for the M10 and 800P

Please see your Intel representative with any questions or concerns regarding the announcement herein.

Products Affected / Intel Ordering Codes:

<table>
<thead>
<tr>
<th>Marketing Name</th>
<th>Product Code</th>
<th>MM#</th>
<th>Pack Size</th>
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<tbody>
<tr>
<td>Intel® Optane™ Memory M10 Series</td>
<td>MEMPEK1J016GA01</td>
<td>960260</td>
<td>Generic Single Pack</td>
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<tr>
<td>Intel® Optane™ Memory M10 Series</td>
<td>MEMPEK1J032GA01</td>
<td>960261</td>
<td>Generic Single Pack</td>
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<tr>
<td>Intel® Optane™ Memory M10 Series</td>
<td>MEMPEK1J064GA01</td>
<td>960262</td>
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<tr>
<td>Intel® Optane™ Memory M10 Series</td>
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<td>960268</td>
<td>Generic 100 Pack</td>
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<tr>
<td>Intel® Optane™ Memory M10 Series</td>
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<td>960270</td>
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<td>960272</td>
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<tr>
<td>Intel® Optane™ Memory M10 Series</td>
<td>MEMPEK1J016GAXT</td>
<td>962391</td>
<td>Retail Box 10 Pack</td>
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<td>Intel® Optane™ Memory M10 Series</td>
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<td>962392</td>
<td>Retail Box 10 Pack</td>
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PCN Revision History:

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<th>Date of Revision:</th>
<th>Revision Number:</th>
<th>Reason:</th>
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<tbody>
<tr>
<td>January 13, 2021</td>
<td>00</td>
<td>Originally Published PCN</td>
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118018 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com
Asia Pacific/PRC Contact: apageceb@intel.com
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